



# HCF55R150

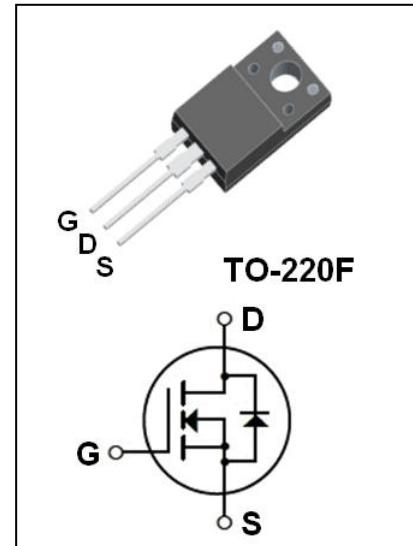
550V N-Channel Super Junction Power MOSFET

## ● Features:

- 24.0A, 550V,  $R_{DS(on)(Typ)} = 125m\Omega$  @  $V_{GS} = 10V$
- Low Gate Charge
- Low  $C_{rss}$
- 100% Avalanche Tested
- Fast Switching
- Improved dv/dt Capability

## ● Application:

- High Frequency Switching Mode Power Supply
- Active Power Factor Correction



## Absolute Maximum Ratings ( $T_c = 25^\circ C$ unless otherwise noted)

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain-Source Voltage	550	V
$I_D$	Drain Current - Continuous ( $T_c = 25^\circ C$ )	24.0*	A
	- Continuous ( $T_c = 100^\circ C$ )	15.1*	A
$I_{DM}$	Drain Current - Pulsed (Note1)	96*	A
$V_{GSS}$	Gate-Source Voltage	$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy (Limit Reference Value) (Note2)	665	mJ
$I_{AR}$	Avalanche Current (Note1)	11.0	A
$E_{AR}$	Repetitive Avalanche Energy (Note1)	8.1	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ (Note3)	8.5	V/ns
$P_D$	Power Dissipation ( $T_c = 25^\circ C$ )	58	W
	-Derate above $25^\circ C$	0.46	W/ $^\circ C$
$T_j$	Operating Junction Temperature	150	$^\circ C$
$T_{stg}$	Storage Temperature Range	-55 to +150	$^\circ C$

\* Drain Current Limited by Maximum Junction Temperature.

## Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.16	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	80	$^\circ C/W$

	HCF55R150					
	550V N-Channel Super Junction Power MOSFET					

### Electrical Characteristics(Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditons	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
BV <sub>DSS</sub>	Drain-source Breakdown Voltage	V <sub>GS</sub> =0V ,I <sub>D</sub> =250μA	550	--	--	V
△BV <sub>DSS</sub> /△T <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> =250μA (Referenced to 25°C)	--	0.62	--	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =550V,V <sub>GS</sub> =0V	--	--	1	μA
		V <sub>DS</sub> =440V,Tc=125°C	--	--	10	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current,Forward	V <sub>GS</sub> =+30V, V <sub>DS</sub> =0V	--	--	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current,Reverse	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V	--	--	-100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0	--	4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10 V, I <sub>D</sub> =12A	--	125	150	mΩ
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =20 V, I <sub>D</sub> =12A (Note4)	--	15.8	--	S
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V, f=1.0MHz	--	1480	--	pF
C <sub>oss</sub>	Output Capacitance		--	84	--	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	4.8	--	pF
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 24 A, R <sub>G</sub> = 25 Ω (Note4,5)	--	22	--	ns
t <sub>r</sub>	Turn-On Rise Time		--	75	--	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		--	215	--	ns
t <sub>f</sub>	Turn-Off Fall Time		--	66	--	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 480 V, I <sub>D</sub> =24 A, V <sub>GS</sub> = 10 V (Note4,5)	--	50	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	12.5	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	25.8	--	nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>s</sub>	Maximum Continuous Drain-Source Diode Forward Current		--	--	24	A
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		--	--	96	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> =0V,I <sub>s</sub> =24.0A	--	--	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> =0V, I <sub>s</sub> =24.0A, d I <sub>F</sub> /dt=100A/μs (Note4)	--	445	--	ns
Q <sub>rr</sub>	Reverse Recovery Charge		--	7.1	--	μC

Notes:

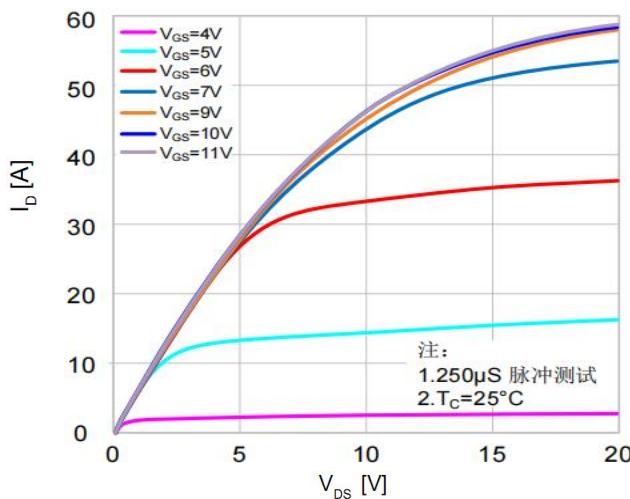
- 1、Repetitive Rating:Pulse Width Limited by Maximum Junction Temperature.
- 2、L = 10mH, I<sub>AS</sub> =11.0A, V<sub>DD</sub> = 100V, R<sub>G</sub> = 25 Ω, Starting T<sub>J</sub> = 25°C.
- 3、I<sub>SD</sub>≤24.0A, di/dt≤200A/μs, V<sub>DD</sub>≤BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C.
- 4、Pulse Test : Pulse Width ≤300 μ s, Duty Cycle≤2%.
- 5、Essentially Independent of Operating Temperature.



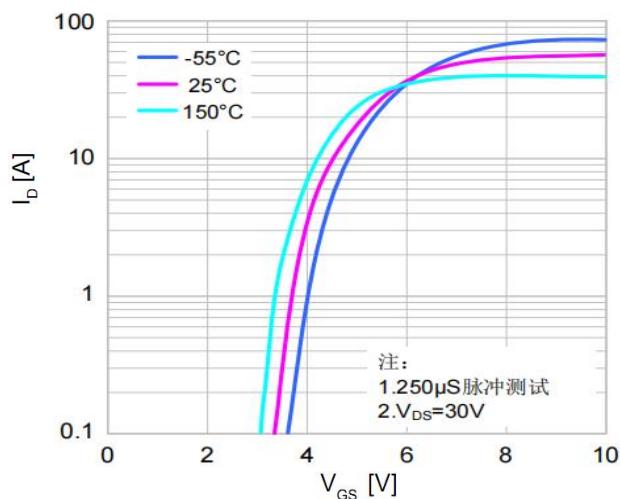
HCF55R150

550V N-Channel Super Junction Power MOSFET

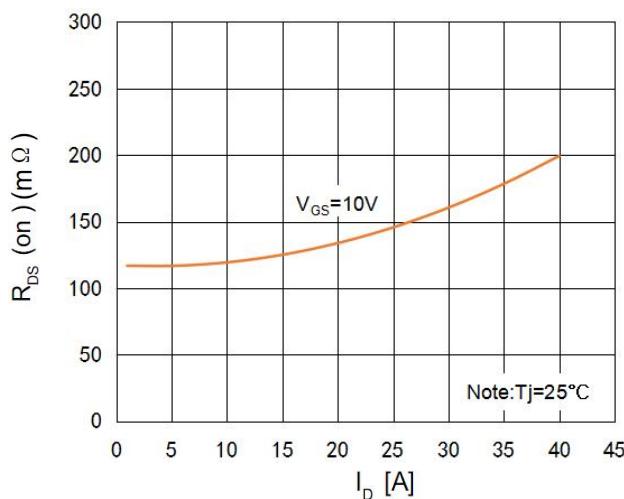
### On-Region Characteristics



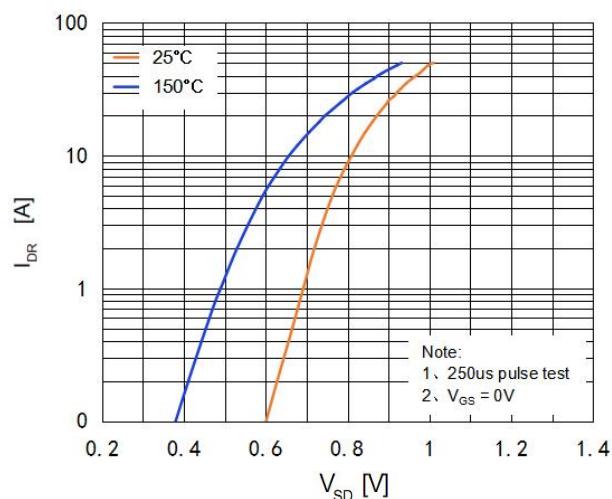
### Transfer Characteristics



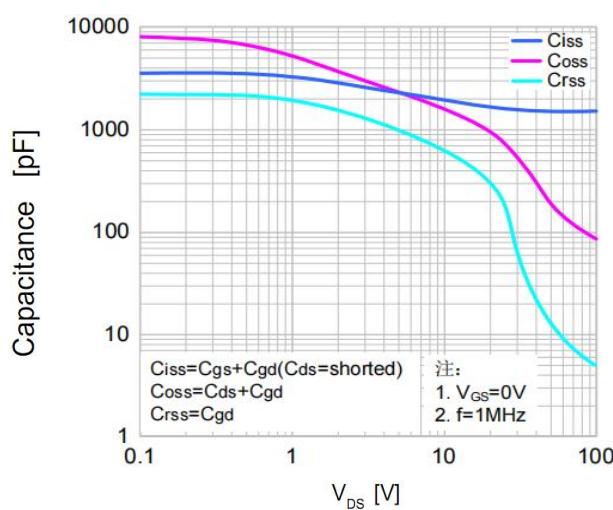
### On-Resistance Variation vs. Drain Current and Gate Voltage



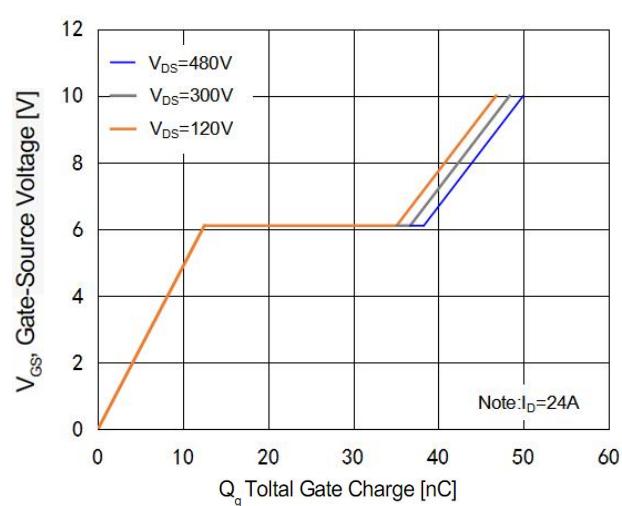
### Body Diode Forward Voltage Variation vs. Source Current and Temperature



### Capacitance Characteristics



### Gate Charge Characteristics

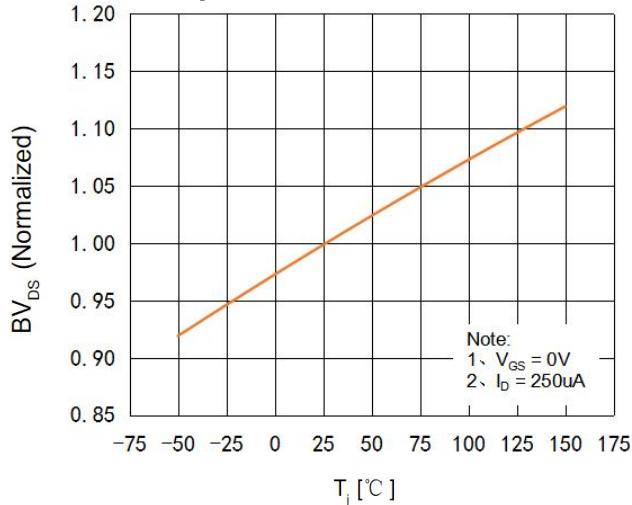




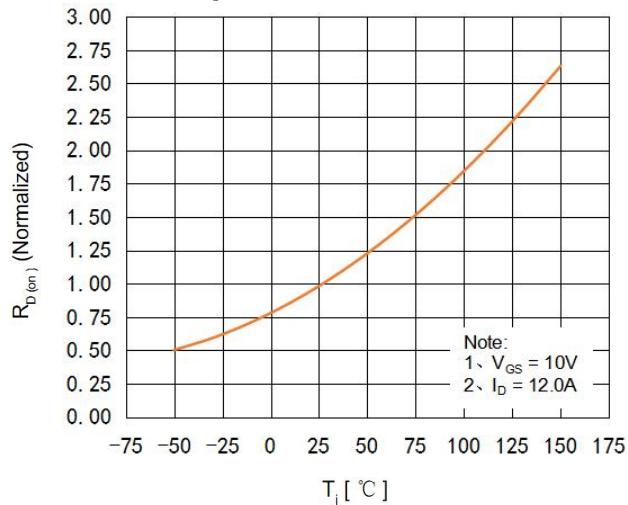
# HCF55R150

## 550V N-Channel Super Junction Power MOSFET

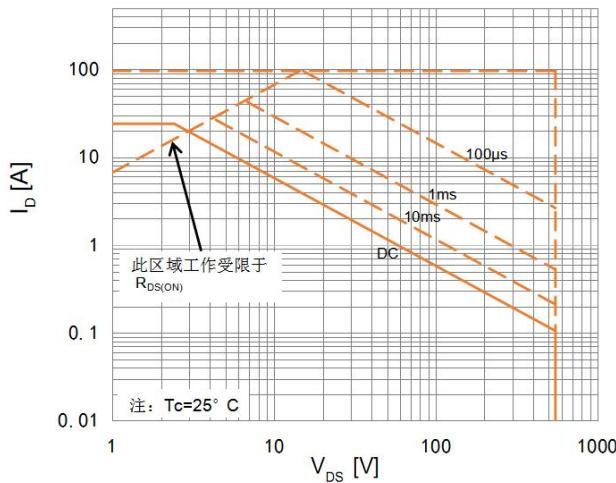
### Breakdown Voltage Variation vs. Temperature



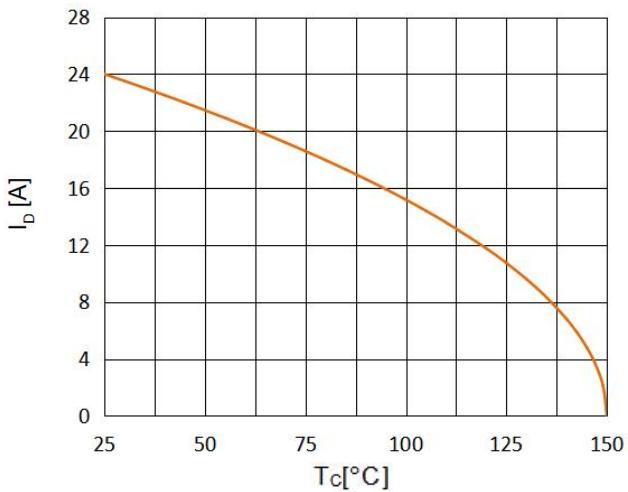
### On-Resistance Variation vs. Temperature



### Maximum Safe Operating Area



### Maximum Drain Current Vs. Case Temperature



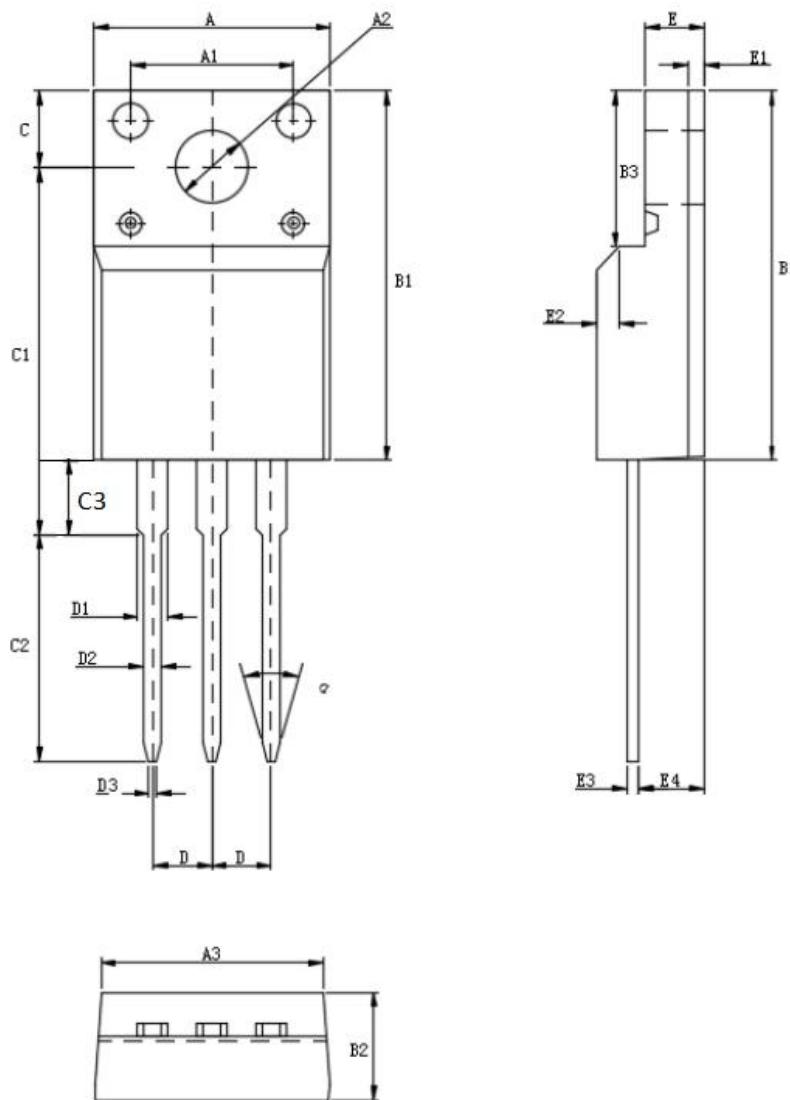
**HCF55R150**

550V N-Channel Super Junction Power MOSFET

**TO-220F Package Dimensions**

UNIT: mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	9.80		10.60	D		2.54	
A1		7.00		D1	1.15		1.47
A2	2.90		3.40	D2	0.60		0.90
A3	9.10		9.90	D3	0.20		0.50
B1	15.40		16.40	E	2.24		2.84
B2	4.35		4.95	E1		0.70	
B3	6.00		7.40	E2		1.0 × 45°	
C	3.00		3.70	E3	0.35		0.65
C1	15.00		17.00	E4	2.30		3.30
C2	8.80		10.80	α (度)		30°	
C3	2.60		3.60				





**HCF55R150**

550V N-Channel Super Junction Power MOSFET

注意事项：

- 1、在电路设计时请不要超过器件的最大额定值，否则会影响整机的可靠性。
- 2、MOSFET产品为静电敏感型器件，使用时应注意采取防静电保护措施，如佩戴防静电手环、设备接地等。
- 3、如需安装散热片，请注意控制扭力大小及散热片的平整度。
- 4、该规格书由华科公司制作，并可能不定期更改，恕不另行通知。
- 5、如有疑问，请及时联系我司销售代表。

版本履历表：

序号	版本号	修改时间	修改记录
1	V1.0	2022-12-20	首次发行